

8-bit Proprietary Microcontroller

CMOS

F²MC-8L MB89120/120A Series

MB89121/123A/125A/P131/P133A/P135A MB89PV130A

■ DESCRIPTION

The MB89120 series is a line of single-chip microcontrollers containing a compact instruction set and a great variety of peripheral functions such as a timer, serial interface, and external interrupt. The MB89120A series is an extended variant of the MB89120, with a remote control transmission function and wake-up interrupt function.

■ FEATURES

- F²MC-8L family CPU core
- Low-voltage operation
- Low current consumption (allowing for dual clock)
- Minimum execution time : 0.95 μ s at 4.2 MHz
- 21-bit time-base counter
- I/O ports : Max. 36 ports
- External interrupts : 3 channels
- External interrupts (wake-up function) : 8 channels (only for the MB89120A series)
- 8-bit serial I/O : 1 channel
- 8/16-bit timer/counter : 1 channel
- Built-in remote-control transmitting frequency generator (only for the MB89120A series)
- Low-power consumption modes (stop mode, sleep mode, watch mode)
- Package : QFP-48
- CMOS technology

For the information for microcontroller supports, see the following web site.

<http://edevic.fujitsu.com/micom/en-support/>

MBMB89120/120A Series

■ PRODUCT LINEUP

Part number Item	MB89121	MB89123A	MB89125A	MB89P133A	MB89P131
Classification	Mass-produced products (Mask ROM products)			One-time products	
ROM size	4 K × 8 bits (internal mask ROM)	8 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal mask ROM)	8 K × 8 bits (Internal PROM to be programmed with a general-purpose EPROM programmer)	4 K × 8 bits (Internal PROM to be programmed with a general-purpose EPROM programmer)
RAM size	128 × 8 bits	256 × 8 bits			128 × 8 bits
CPU functions	The number of instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, 16 bits Minimum execution time : 0.95 μs at 4.2 MHz Minimum interrupt processing time : 8.57 μs at 4.2 MHz				
Ports	Output ports (N-ch open-drain) : 4 (All also serves as peripherals.) Output ports (CMOS) : 8 I/O ports (CMOS) : 24 (8 ports also serve as peripherals.) Total : 36				
Timer/counter	8-bit timer/counter × 2 channels or 16-bit event counter × 1 channel				
Serial I/O	8 bits LSB/MSB first selectable				
External interrupt 1	3 independent channels (edge selection, interrupt vector, source flag) Rising edge/falling edge/both edges selectable Also for wake-up from stop/sleep mode (edge detection is also permitted in stop mode)				
External interrupt 2 (wake-up function)	—	8 channels (only for level detection)			—
Remote control transmitting frequency generator	—	1 channel (pulse width and frequency selectable by program)			—
Standby mode	Sleep mode, stop mode, watch mode				
Process	CMOS				
Operating voltage*	2.2 V to 4.0 V (with the dual clock option) 2.2 V to 6.0 V (with the single clock option)			2.7 V to 6.0 V	
EPROM for use	—				

* : Varies with conditions such as operating frequencies. (See “■ ELECTRICAL CHARACTERISTICS”.)

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MBMB89120/120A Series

(Continued)

Part number Item	MB89P135A	MB89PV130A
Classification	One-time PROM product	Piggyback/evaluation product
ROM size	16 K × 8 bits (internal PROM, to be programmed with general-purpose EPROM programmer)	32 K × 8 bits (external ROM)
RAM size	512 × 8 bits	1 K × 8 bits
CPU functions	The number of instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, 16 bits Minimum instruction execution time : 0.95 μs at 4.2 MHz Minimum interrupt processing time : 8.57 μs at 4.2 MHz	
Ports	Output ports (N-ch open-drain ports) : 4 (All also serve as peripherals.) Output ports (CMOS) : 8 I/O ports (CMOS) : 24 (8 ports also serve as peripherals.) Total : 36	
Timer/counter	8-bit timer/counter × 2 channels or 16-bit event counter × 1 channel	
Serial I/O	8 bits LSB/MSB first selectable	
External interrupt 1	3 independent channels (edge selection, interrupt vector, source flag) Rising/falling/both edges selectable Used also for wake-up from stop/sleep mode. (Edge detection is also permitted in stop mode.)	
External interrupt 2 (wake-up function)	8 channels (only for level detection)	
Remote control transmitting fre- quency generator	1 channel (Pulse width and cycle selectable by program)	
Standby mode	Sleep mode, stop mode, and watch mode	
Process	CMOS	
Operating voltage	2.7 V to 6.0 V	2.7 V to 6.0 V
EPROM for use	—	MBM27C256A-20TVM

MBMB89120/120A Series

■ PACKAGE AND CORRESPONDING PRODUCTS

Package	MB89121	MB89123A	MB89125A	MB89P133A	MB89P131
FPT-48P-M13	○	○	○	○	○
MQP-48C-P01	×	×	×	×	×

Package	MB89P135A	MB89PV130A
FPT-48P-M13	○	×
MQP-48C-P01	×	○

○ : Available, × : Not available

Note : Package details of OTPROM products and piggyback/evaluation products are common to those of MB89130/130A series. Refer to the MB89130/130A series data sheet for details.

■ DIFFERENCES AMONG PRODUCTS

1. Memory Size

Before evaluating using the one-time ROM product, verify its difference from the product that will actually be used. Take particular care on the following points :

- The available number of register banks is different among the MB89121, the MB89123A/125A, and P135A/PV130A.
- The stack area, etc., is set at the upper limit of the RAM.

2. Current Consumption

- When operated at low-speed, a product with an OTPROM (EPROM) will consume more current than a product with a mask ROM. However, the current consumption in the sleep/stop mode is the same. (For more information, see “■ ELECTRICAL CHARACTERISTICS”.)
- In the case of the MB89PV130A, added is the current consumed by the EPROM which is connected to the top socket.

3. Mask Options

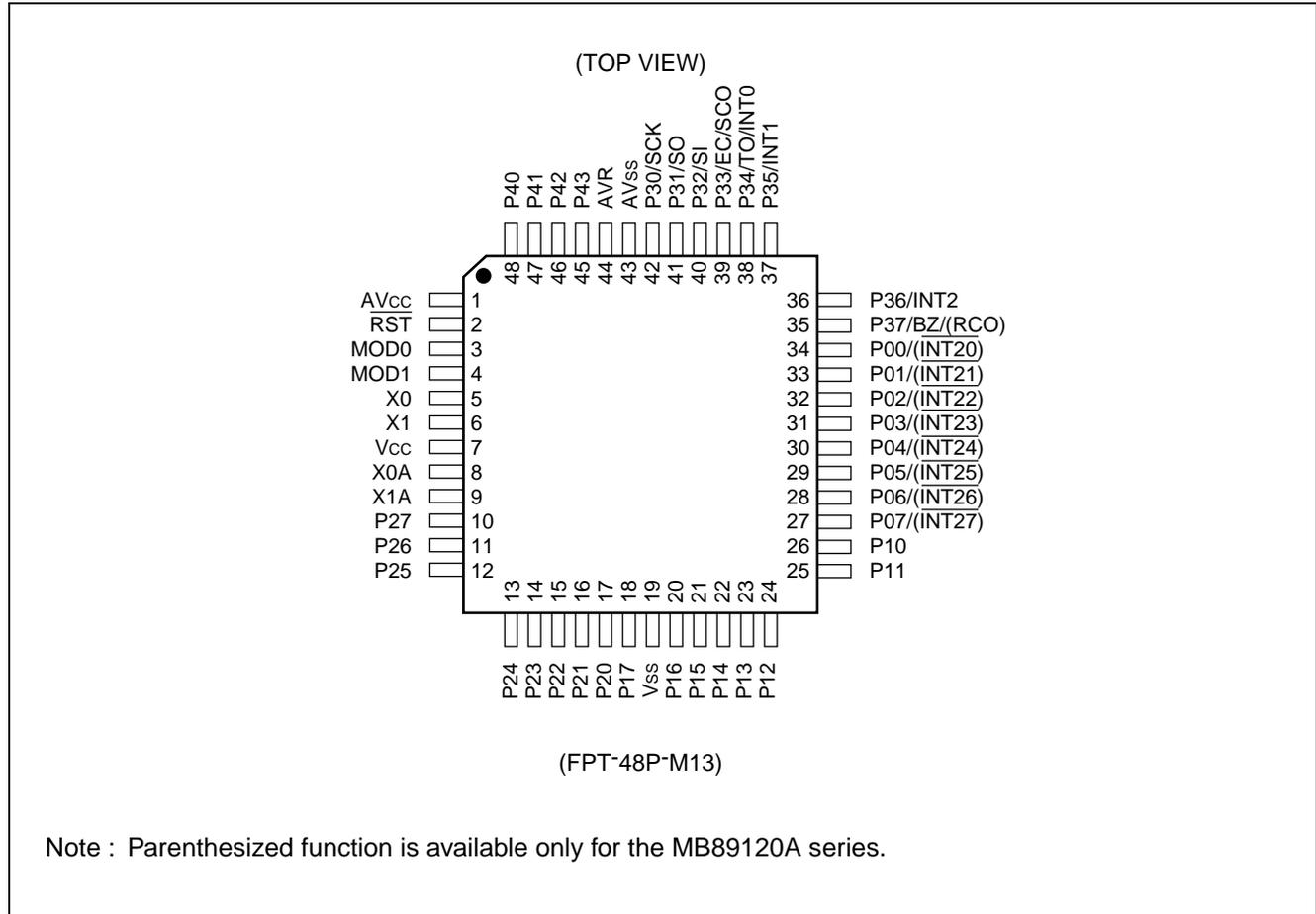
Functions that can be selected as options and how to designate these options vary with product. Before using options, check “■ MASK OPTIONS”.

Take particular care on the following point :

- Pull-up resistor cannot be set for P40 to P43 on the MB89P135A.
- Options are fixed on the MB89PV130A.

MBMB89120/120A Series

■ PIN ASSIGNMENT



MBMB89120/120A Series

■ PIN DESCRIPTION

Pin no.	Pin name	Circuit type	Function
5	X0	A	Main clock crystal oscillator pins (max. 4.2 MHz)
6	X1		
8	X0A	B	Sub clock crystal oscillator pins (for 32.768 kHz)
9	X1A		
3	MOD0	C	Operation mode select pins Connect these pins directly to V _{SS} .
4	MOD1		
2	$\overline{\text{RST}}$	D	Reset I/O pin This port is of N-ch open-drain output type with pull-up resistor and a hysteresis input type. The internal circuit is initialized by the input of "L". "L" is output from this pin by an internal reset source as optional setting.
27 to 34	P07/ ($\overline{\text{INT27}}$) to P00/ ($\overline{\text{INT20}}$)	I	General-purpose I/O ports On the MB89120A series, these pins also serve as external interrupt input. External interrupt input pins are hysteresis input.
18, 20 to 26	P17 to P10	E	General-purpose I/O ports
10 to 17	P27 to P20	G	General-purpose output-only ports
42	P30/SCK	F	General-purpose I/O port Also serves as clock I/O for the 8-bit serial I/O interface. This port is of hysteresis input type.
41	P31/SO	F	General-purpose I/O port Also serves as a serial I/O data output. This port is hysteresis input type.
40	P32/SI	F	General-purpose I/O port Also serves as a serial I/O data input. This port is hysteresis input type.
39	P33/EC/SCO	F	General-purpose I/O port Also serves as the external clock input for the 8-bit timer/counter. This port is hysteresis input type. System clock output is optional.
38	P34/TO/INT0	F	General-purpose I/O port Also serves as the overflow output and external interrupt input for the 8-bit timer/counter. This port is hysteresis input type.
36, 37	P36/INT2, P35/INT1	F	General-purpose I/O ports Also serve as an external interrupt input. These ports are hysteresis input type.
35	P37/BZ/ (RCO)	F	General-purpose I/O port Also serves as a buzzer output. This port is hysteresis input type. On the MB89120A series, the pin also serves as a remote control output.

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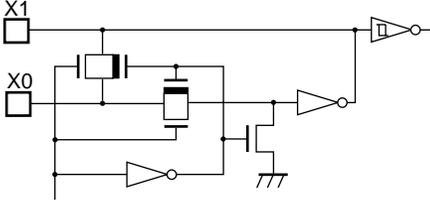
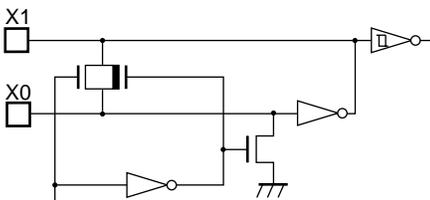
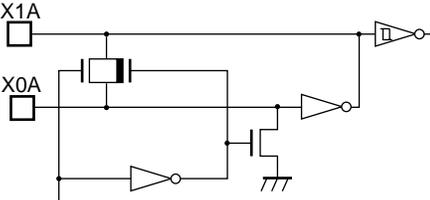
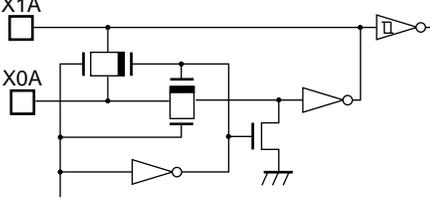
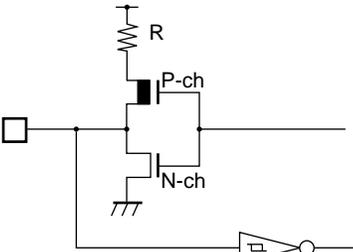
MBMB89120/120A Series

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Pin no.	Pin name	Circuit type	Function
45 to 48	P43 to P40	H	N-ch open-drain output ports
7	V _{CC}	—	Power supply pin
19	V _{SS}	—	Power supply (GND) pin
1	AV _{CC}	—	Power supply pin Use this pin at the same voltage as V _{CC} .
44	AVR	—	Reference voltage input pin
43	AV _{SS}	—	Power supply (GND) pin Use this pin at the same voltage as V _{SS} .

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■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	 <p>Standby control signal</p>	<ul style="list-style-type: none"> Crystal and ceramic oscillation type (main clock) Circuit for the MB89P133A/P131/P135A/PV130A External clock input select versions of MB89121/123A/125A At an oscillation feedback resistor of approximately 1 MΩ / 5 V
	 <p>Standby control signal</p>	<ul style="list-style-type: none"> Crystal and ceramic oscillation type (main clock) Crystal or ceramic oscillator select versions of MB89121/123A/125A At an oscillation feedback resistor of approximately 1 MΩ / 5 V
B	 <p>Standby control signal</p>	<ul style="list-style-type: none"> Crystal and ceramic oscillation type (sub clock) Circuit for the MB89121/123A/125A At an oscillation feedback resistor of approximately 4.5 MΩ / 5 V
	 <p>Standby control signal</p>	<ul style="list-style-type: none"> Crystal and ceramic oscillation type (sub clock) Circuit for the MB89P131/P133A/P135A/PV130A At an oscillation feedback resistor of approximately 4.5 MΩ / 5 V
C		
D		<ul style="list-style-type: none"> Output pull-up resistor (P-ch) of approximately 50 kΩ / 5 V Hysteresis input

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MBMB89120/120A Series

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Type	Circuit	Remarks
E		<ul style="list-style-type: none"> • CMOS output • CMOS input • Pull-up resistor optional
F		<ul style="list-style-type: none"> • CMOS output • Hysteresis input • Pull-up resistor optional
G		<ul style="list-style-type: none"> • CMOS output
H		<ul style="list-style-type: none"> • N-ch open-drain output • Pull-up resistor optional
I	<p>Only for the MB89120A series</p>	<ul style="list-style-type: none"> • CMOS output • CMOS input • The interrupt input is a hysteresis input (available only for the MB89120A series) . • Pull-up resistor optional

■ HANDLING DEVICES

1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- and high- withstand voltage pins, or if higher than the voltage which shows on “1. Absolute Maximum Ratings” in “■ ELECTRICAL CHARACTERISTICS” is applied between V_{CC} and V_{SS} .

When latchup occurs, power supply current increases rapidly, and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

Also, take care to prevent the analog power supply (AV_{CC} and AVR) and analog input from exceeding the digital power supply (V_{CC}) when the analog system power supply is turned on and off.

2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to pull-up or pull-down resistor.

3. Treatment of N.C. Pins

Be sure to leave N.C. (internally connected) pins open.

4. Power Supply Voltage Fluctuations

Although operation is assured within the rated range of V_{CC} power supply voltage, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that V_{CC} ripple fluctuations (P-P value) will be less than 10% of the standard V_{CC} value at the commercial frequency (50 to 60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

5. Precautions when Using an External Clock

When an external clock is used, oscillation stabilization time is required even for power-on reset (optional) and release from stop mode.

6. Turning on the supply voltage (only for the MB89P135A)

When the power supply is turned on if MB89P135A is used, power on sharply up to 2.0 V within 13 clock cycles after starting of oscillation.

Further, various options may not be set, if power supply is turned on without the above condition.

■ PROGRAMMING TO THE PROM ON THE MB89P131

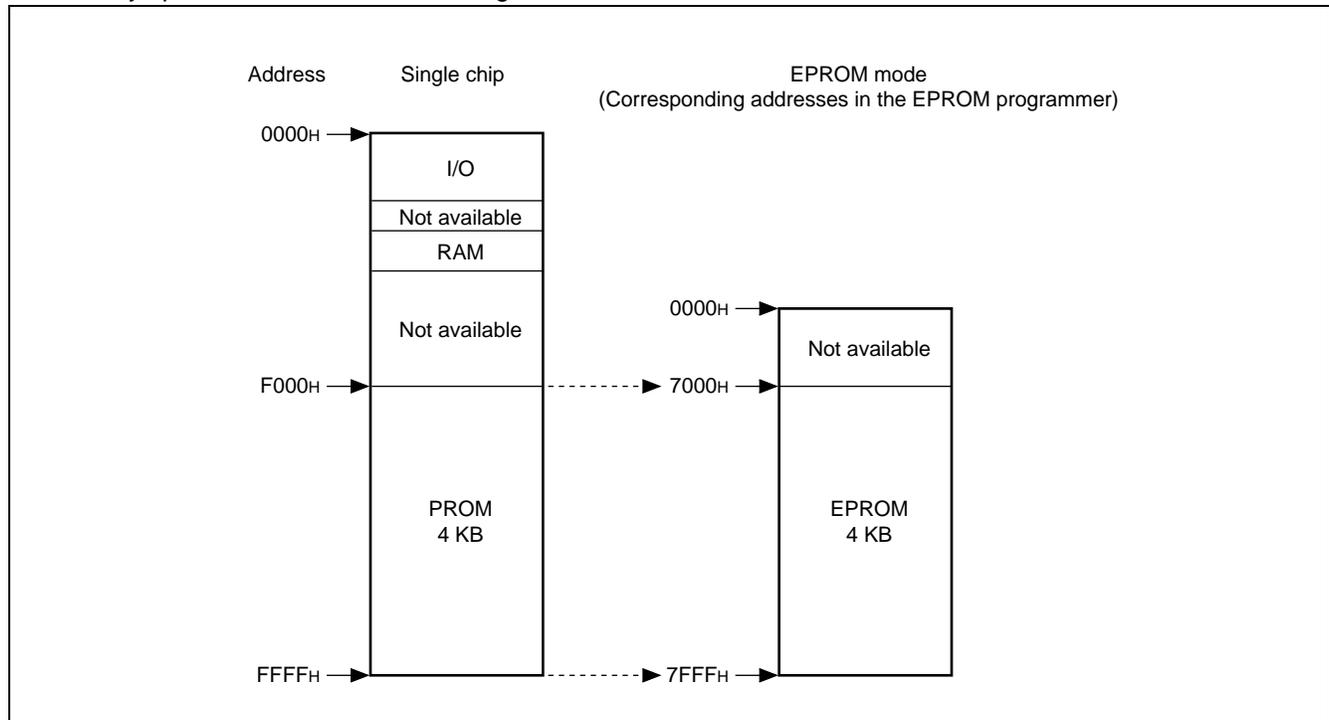
The MB89P131 is a one-time PROM version of the MB89121.

1. Features

- 4-Kbyte PROM on chip
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in EPROM mode is diagrammed below :



3. Programming to the PROM

In EPROM mode the MB89P131 functions equivalent to the MBM27C256A. This allows the PROM to be programmed with a general-purpose EPROM programmer by using the dedicated socket adapter. Note, however, that the electronic signature mode cannot be used.

• Programming procedure

- (1) Set the EPROM programmer to MBM27C256A.
- (2) Load program data into the EPROM programmer at 7000H to 7FFFH (note that addresses F000H to FFFFH while operating as a single chip correspond to 7000H to 7FFFH in EPROM mode) .
- (3) Program with the EPROM programmer.

MBMB89120/120A Series

■ PROGRAMMING TO THE PROM ON THE MB89P133A

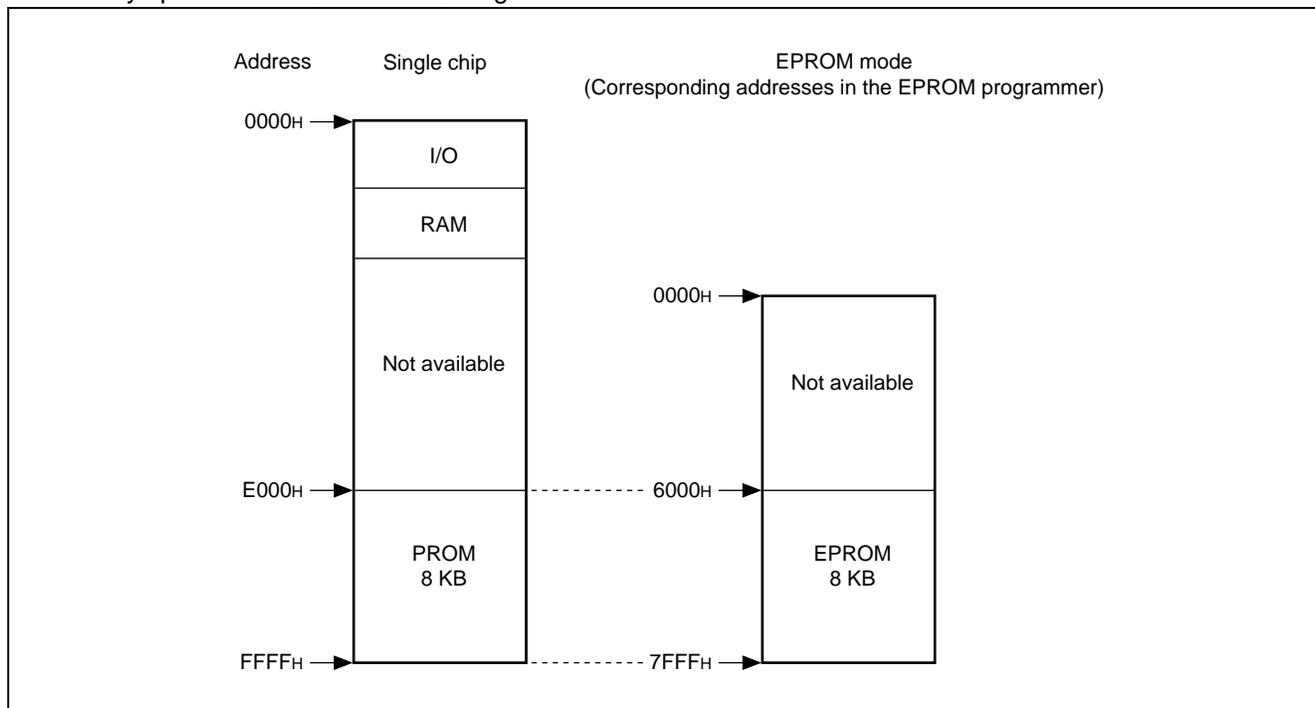
The MB89P133A is a one-time PROM version of the MP89123A.

1. Features

- 8-Kbyte PROM on chip
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in EPROM mode is diagrammed below :



3. Programming to the PROM

In EPROM mode the MB89P133A functions equivalent to the MBM27C256A, This allows the PROM to be programmed with a general-purpose EPROM programmer by using the dedicated socket adapter. Note, however, that the MB89P133A cannot use the electronic signature mode.

• Programming procedure

- (1) Set the EPROM programmer to MBM27C256A.
- (2) Load program data into the EPROM programmer at 6000_H to 7FFF_H (note that addresses E000_H to FFFF_H while operating as a single chip correspond to 6000_H to 7FFF_H in EPROM mode) .
- (3) Program with the EPROM programmer.

■ PROGRAMMING TO THE PROM ON THE MB89P135A

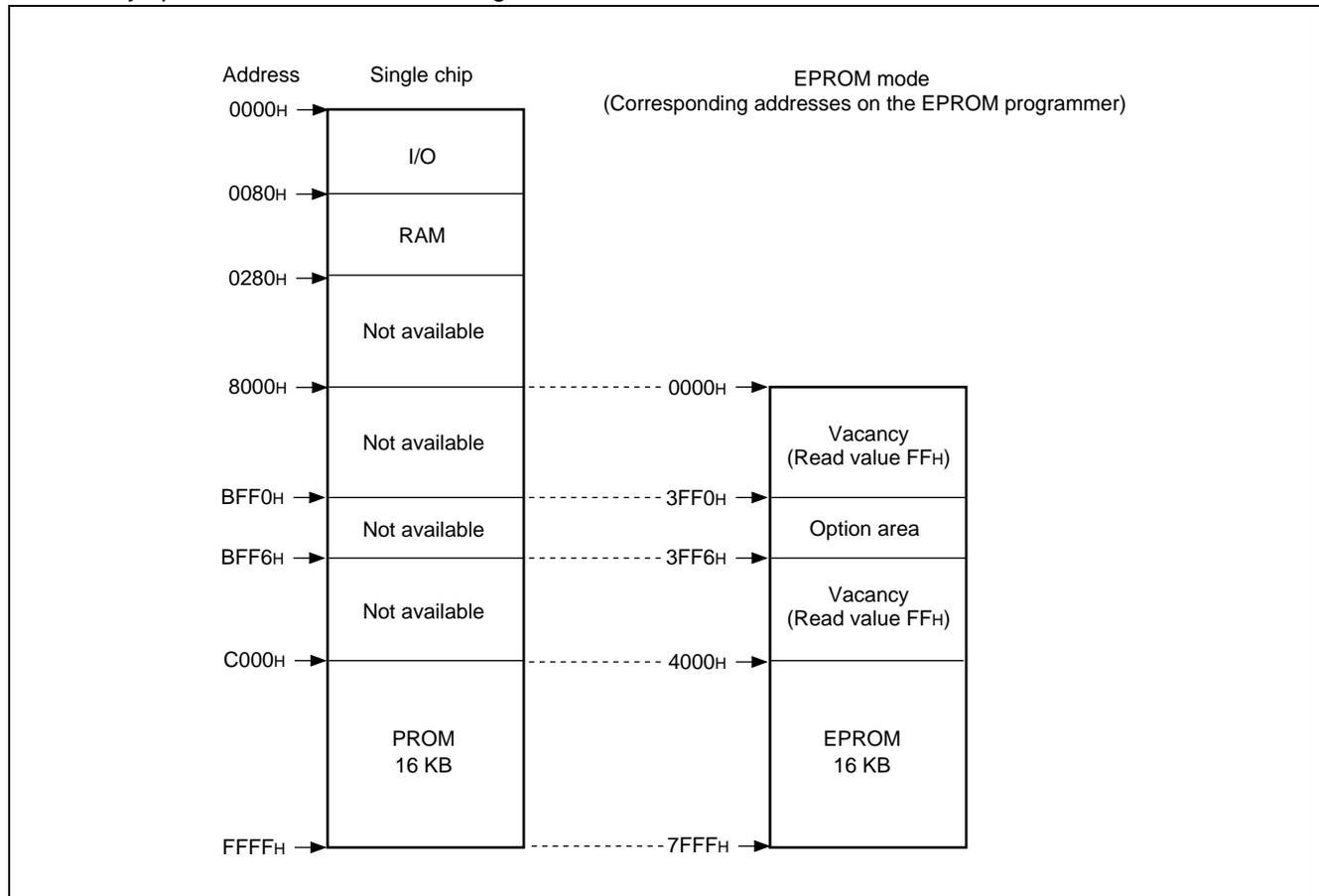
The MB89P135A is an OTPROM version of the MB89123A/125A.

1. Features

- 16-Kbyte PROM on chip
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in EPROM mode is diagrammed below.



3. Programming to the PROM

In EPROM mode, the MB89P135A functions equivalent to the MBM27C256A. This allows the PROM to be programmed with a general-purpose EPROM programmer (the electronic signature mode cannot be used) by using the dedicated socket adapter.

• Programming procedure

- (1) Set the EPROM programmer to the MBM27C256A.
- (2) Load program data into the EPROM programmer at 4000_H to 7FFF_H (note that addresses C000_H to FFFF_H while operating as a single chip correspond to 4000_H to 7FFF_H in EPROM mode) .
- (3) Load option data into the EPROM programmer at 3FF0_H to 3FF6_H.
- (4) Program with the EPROM programmer.

MBMB89120/120A Series

4. Setting PROM Options (MB89P135A Only)

The programming procedure is the same as that for the PROM. Options can be set by programming values at the addresses shown on the memory map. The relationship between bits and options is shown on the following bit map :

• PROM option bit map

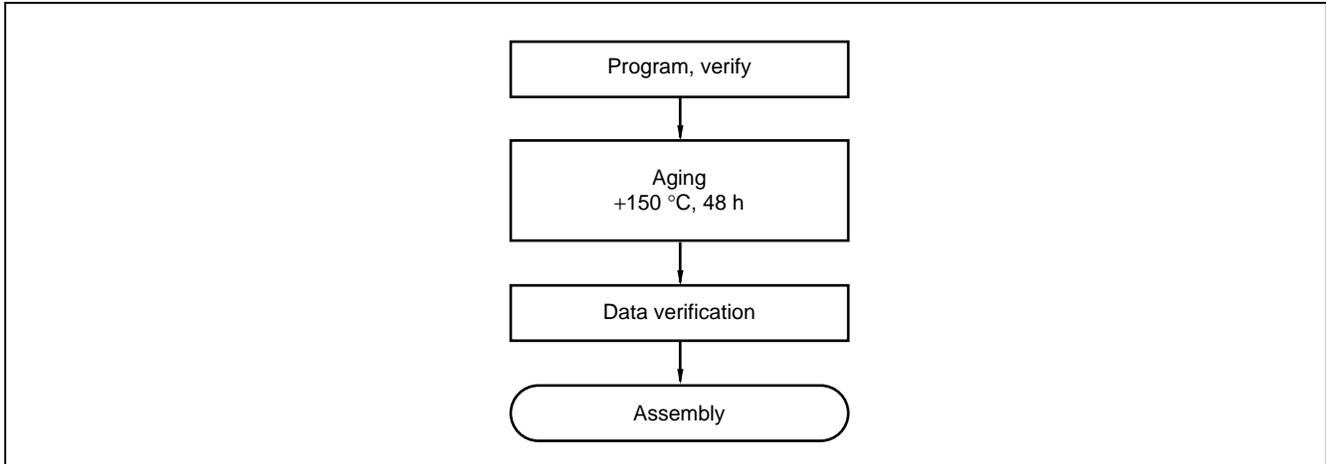
Address	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
3FF0 _H	Vacancy	Vacancy	Vacancy	Clock mode selection	Reset pin output	Power-on reset	Oscillation stabilization time	
	Readable and writable	Readable and writable	Readable and writable	1 : Single clock 0 : Dual clock	1 : Yes 0 : No	1 : Yes 0 : No	00 : 2 ² /F _{CH} 01 : 2 ¹² /F _{CH}	10 : 2 ¹⁶ /F _{CH} 11 : 2 ¹⁸ /F _{CH}
3FF1 _H	P07 Pull-up 1 : Yes 0 : No	P06 Pull-up 1 : Yes 0 : No	P05 Pull-up 1 : Yes 0 : No	P04 Pull-up 1 : Yes 0 : No	P03 Pull-up 1 : Yes 0 : No	P02 Pull-up 1 : Yes 0 : No	P01 Pull-up 1 : Yes 0 : No	P00 Pull-up 1 : Yes 0 : No
3FF2 _H	P17 Pull-up 1 : Yes 0 : No	P16 Pull-up 1 : Yes 0 : No	P15 Pull-up 1 : Yes 0 : No	P14 Pull-up 1 : Yes 0 : No	P13 Pull-up 1 : Yes 0 : No	P12 Pull-up 1 : Yes 0 : No	P11 Pull-up 1 : Yes 0 : No	P10 Pull-up 1 : Yes 0 : No
3FF3 _H	P37 Pull-up 1 : Yes 0 : No	P36 Pull-up 1 : Yes 0 : No	P35 Pull-up 1 : Yes 0 : No	P34 Pull-up 1 : Yes 0 : No	P33 Pull-up 1 : Yes 0 : No	P32 Pull-up 1 : Yes 0 : No	P31 Pull-up 1 : Yes 0 : No	P30 Pull-up 1 : Yes 0 : No
3FF4 _H	Vacancy Readable and writable	Vacancy Readable and writable						
3FF5 _H	Vacancy Readable and writable	Vacancy Readable and writable						
3FF6 _H	Vacancy Readable and writable	Vacancy Readable and writable						

Note : Each bit is set to "1" as the initialized value, therefore the pull-up option is selected.

■ HANDLING MB89P131/P133A/P135A

1. Recommended Screening Conditions

High-temperature aging is recommended as the pre-assembly screening procedure.



2. Programming Yield

Due to its nature, bit programming test cannot be conducted as Fujitsu delivery test. For this reason, a programming yield of 100% cannot be assured at all times.

MBMB89120/120A Series

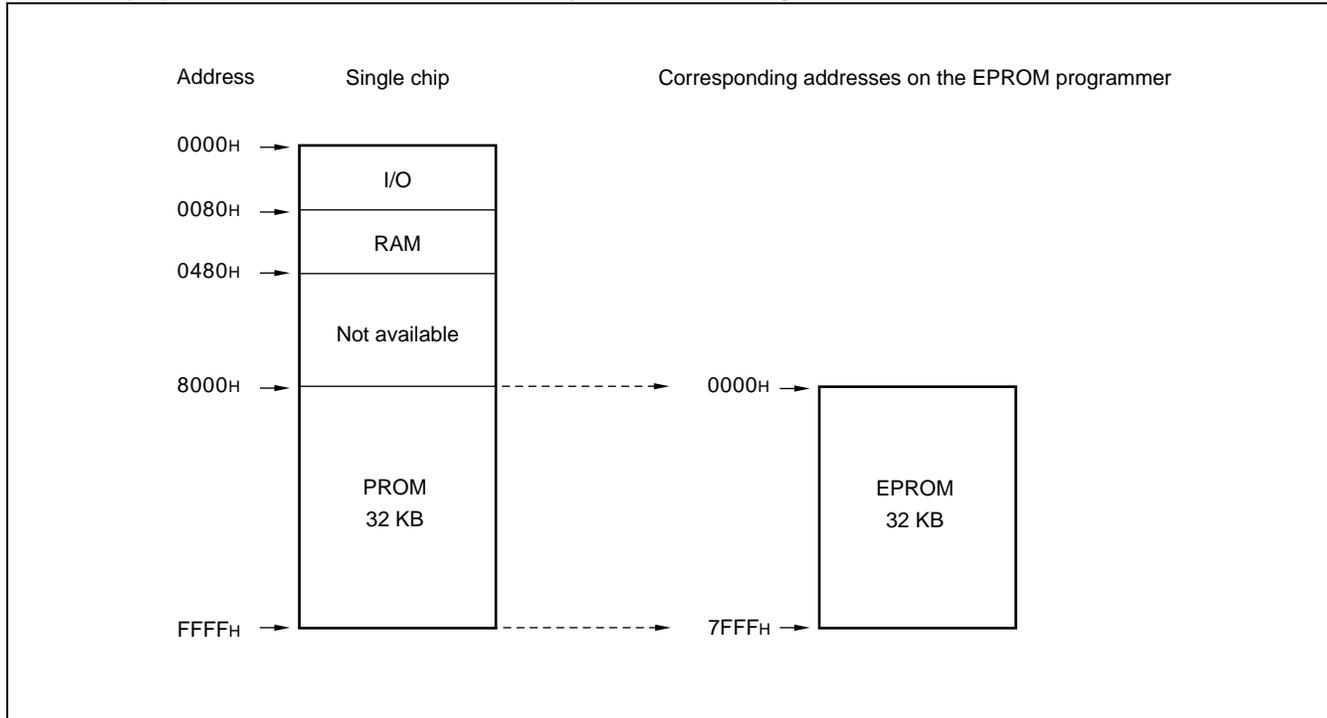
■ PROGRAMMING TO THE EPROM WITH PIGGYBACK/EVALUATION DEVICE

1. EPROM for Use

MBM27C256A-20TVM

2. Memory Space

Memory space in each mode, such as 32-Kbyte EPROM is diagrammed below.

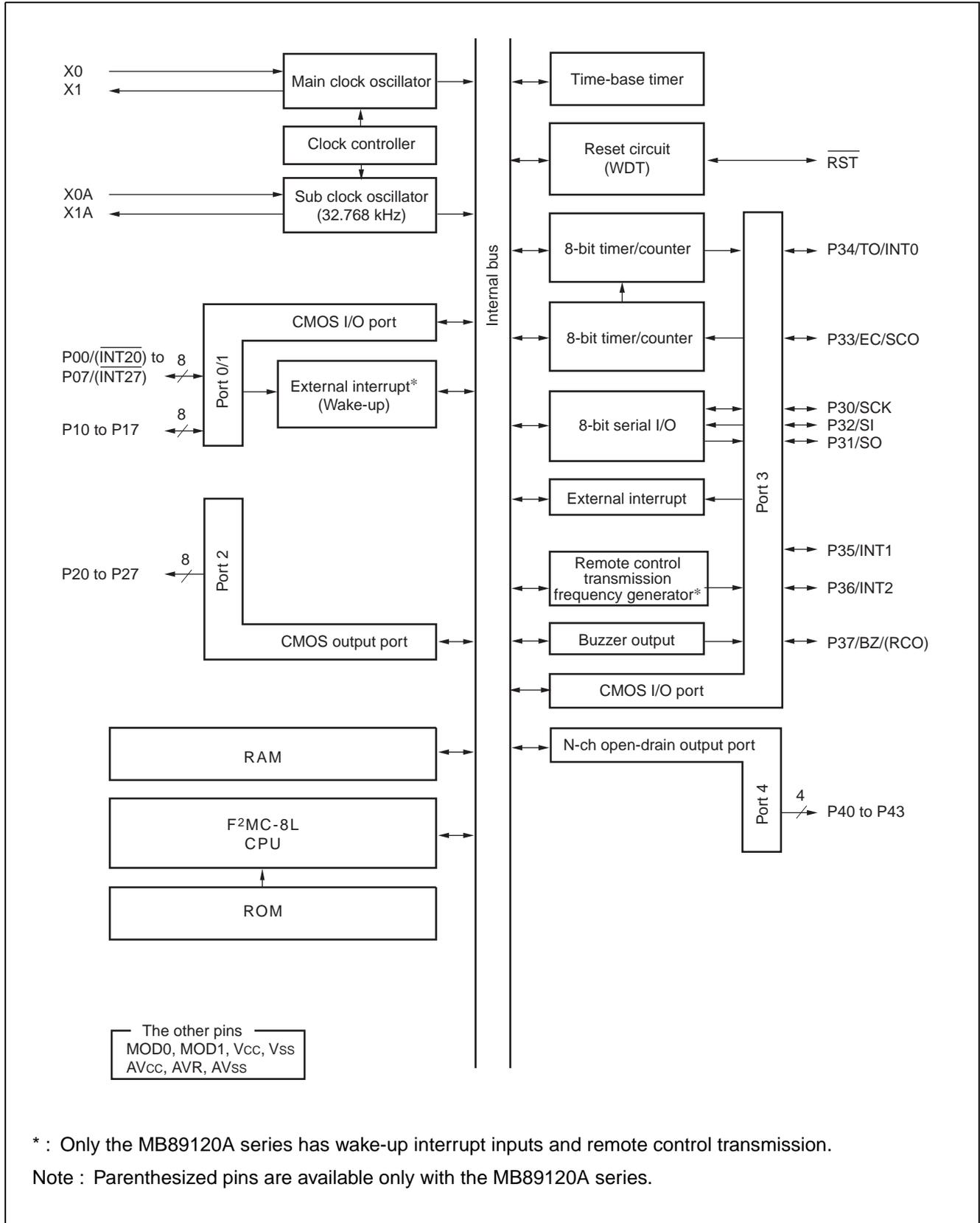


3. Programming to the EPROM

- (1) Set the EPROM programmer for the MBM27C256A.
- (2) Load program data into the EPROM programmer at 0000H to 7FFFH.
- (3) Program with the EPROM programmer.

MBMB89120/120A Series

■ BLOCK DIAGRAM

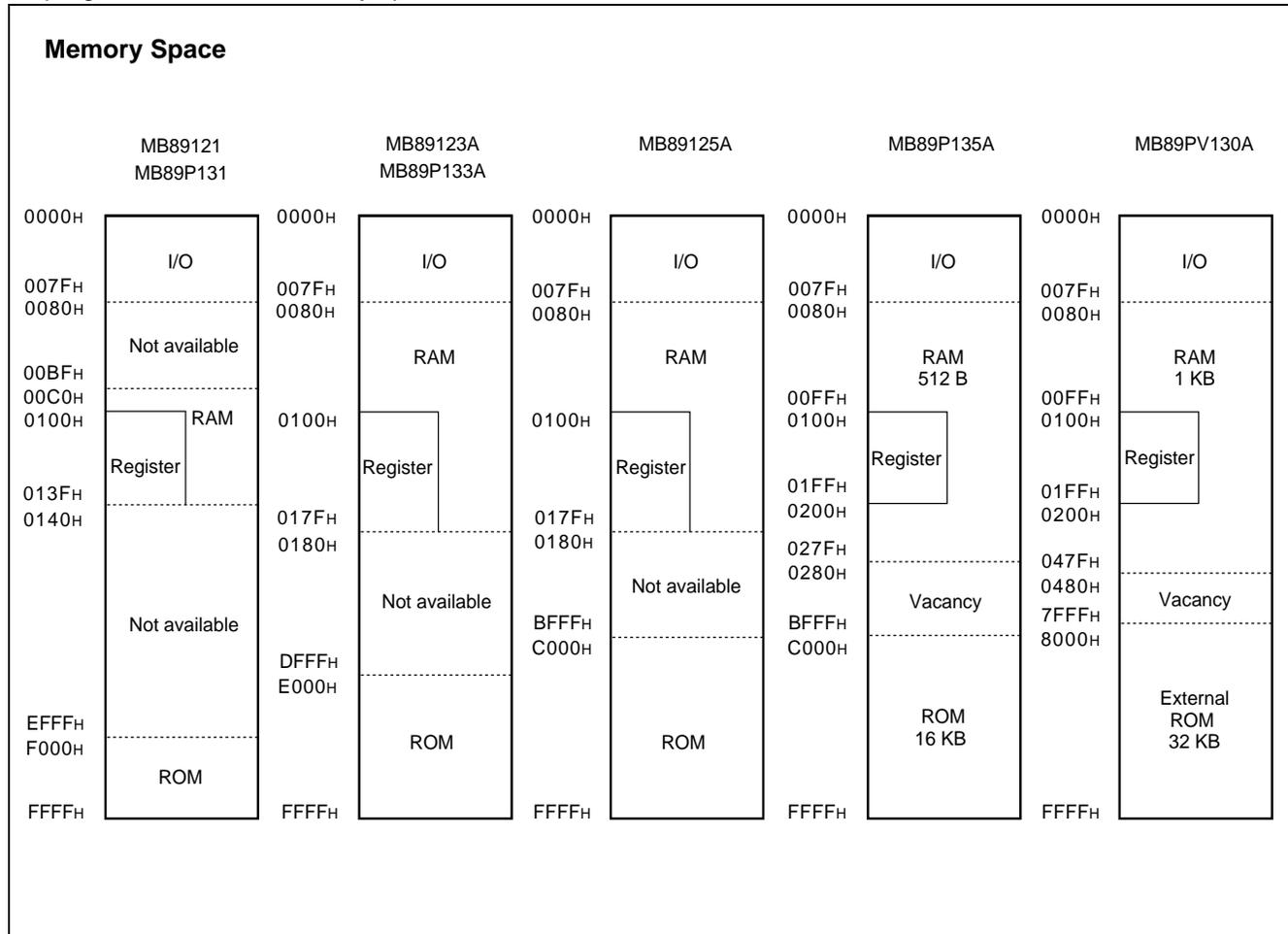


MBMB89120/120A Series

■ CPU CORE

1. Memory Space

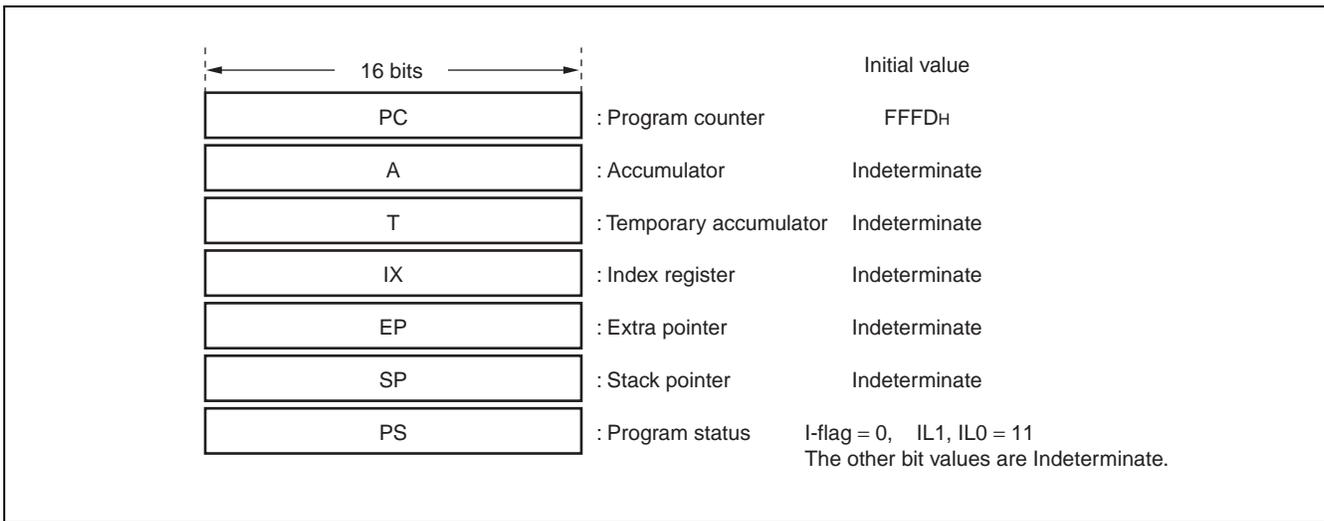
The microcontrollers of the MB89120/120A series offer 64 Kbytes of memory for storing all of I/O, data, and program areas. The I/O area is allocated from the lowest address. The data area is allocated immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is allocated from exactly the opposite end of I/O area, that is, near the highest address. The tables of interrupt reset vectors and vector call instructions are allocated from the highest address with the program area. The memory space of the MB89120/120A series is structured as illustrated below :



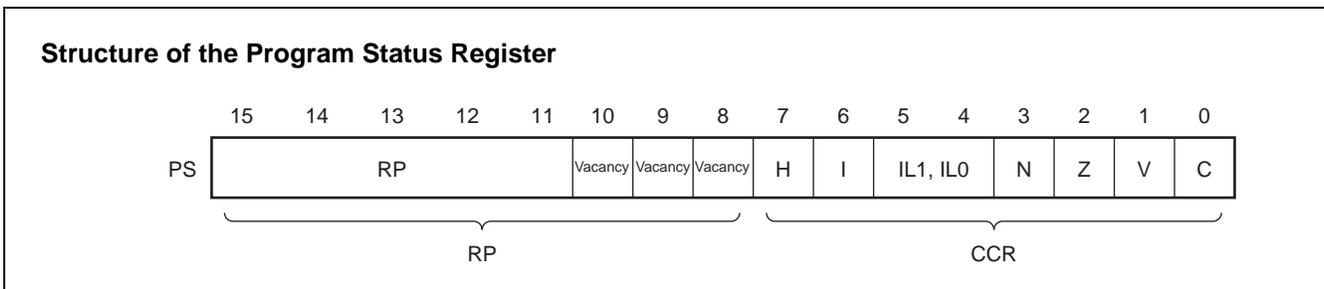
2. Registers

The F²MC-8L family has two types of registers; dedicated hardware registers and general-purpose memory registers. The following dedicated registers are provided :

- Program counter (PC) : A 16-bit register for indicating the instruction storage positions
- Accumulator (A) : A 16-bit temporary register for arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Temporary accumulator (T) : A 16-bit register which is used for arithmetic operations with the accumulator. When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Index register (IX) : A 16-bit register for index modification
- Extra pointer (EP) : A 16-bit pointer for indicating a memory address
- Stack pointer (SP) : A 16-bit pointer for indicating a stack area
- Program status (PS) : A 16-bit register for storing a register pointer, a condition code



The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and the lower 8 bits for use as a condition code register (CCR) (see the diagram below) .



MBMB89120/120A Series

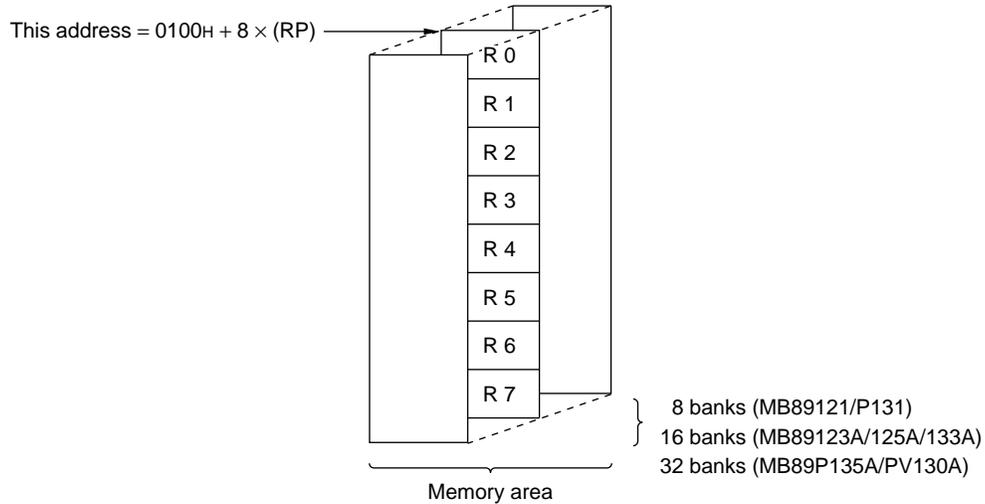
The following general-purpose registers are provided :

General-purpose registers : 8-bit registers for storing data

The general-purpose registers are of 8 bits and located in the register banks of the memory. One bank contains 8 registers and up to a total of 8 banks can be used on the MB89121/P131, and a total of 16 banks can be used on the MB89123A/125A/P133A and a total of 32 banks can be used on the MB89P135A/PV130A.

The bank currently in use is indicated by the register bank pointer (RP) .

Register Bank Configuration



MBMB89120/120A Series

■ I/O MAP

Address	Read/Write	Register name	Register description
00H	(R/W)	PDR0	Port 0 data register
01H	(W)	DDR0	Port 0 data direction register
02H	(R/W)	PDR1	Port 1 data register
03H	(W)	DDR1	Port 1 data direction register
04H	(R/W)	PDR2	Port 2 data register
05H			Vacancy
06H			Vacancy
07H	(R/W)	SYCC	System clock control register
08H	(R/W)	STBC	Standby control register
09H	(R/W)	WDTC	Watchdog control register
0AH	(R/W)	TBTC	Time-base timer control register
0BH	(R/W)	WPCR	Watch prescaler control register
0CH	(R/W)	PDR3	Port 3 data register
0DH	(W)	DDR3	Port 3 data direction register
0EH	(R/W)	PDR4	Port 4 data register
0FH	(R/W)	BZCR	Buzzer register
10H			Vacancy
11H			Vacancy
12H	(R/W)	SCGC	Peripheral control clock register
13H			Vacancy
14H	(R/W)	RCR1	Remote control transmission control register 1*
15H	(R/W)	RCR2	Remote control transmission control register 2*
16H			Vacancy
17H			Vacancy
18H	(R/W)	T2CR	Timer 2 control register
19H	(R/W)	T1CR	Timer 1 control register
1AH	(R/W)	T2DR	Timer 2 data register
1BH	(R/W)	T1DR	Timer 1 data register
1CH	(R/W)	SMR1	Serial mode register
1DH	(R/W)	SDR1	Serial data register
1EH			Vacancy
1FH			Vacancy

(Continued)

MBMB89120/120A Series

(Continued)

Address	Read/write	Register name	Register description
20 _H			Vacancy
21 _H			Vacancy
22 _H			Vacancy
23 _H	(R/W)	EIC1	External interrupt control register 1
24 _H	(R/W)	EIC2	External interrupt control register 2
25 _H			Vacancy
26 _H to 31 _H			Vacancy
32 _H	(R/W)	EIE2	External interrupt 2 enable register*
33 _H	(R/W)	EIF2	External interrupt 2 flag register*
34 _H to 7B _H			Vacancy
7C _H	(W)	ILR1	Interrupt level register 1
7D _H	(W)	ILR2	Interrupt level register 2
7E _H	(W)	ILR3	Interrupt level register 3
7F _H			Vacancy

* : Only in the MB89120A series

Note : Do not use vacancies.

MBMB89120/120A Series

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

($AV_{SS} = V_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Rating		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC} AV_{CC} AVR	$V_{SS} - 0.3$	$V_{SS} + 7.2$	V	Use V_{CC} , AV_{CC} , and AVR set to the same voltage.
Program voltage	V_{PP}	$V_{SS} - 0.6$	$V_{SS} + 13.0$	V	MOD1 pin on the MB89P131/P133A/P135A
Input voltage	V_I	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	
Output voltage	V_O	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	
“L” level maximum output current	I_{OL}	—	10	mA	
“L” level average output current	I_{OLAV}	—	4	mA	Average value (operating current × operating rate)
“L” level total maximum output current	ΣI_{OL}	—	100	mA	
“L” level total average output current	ΣI_{OLAV}	—	20	mA	Average value (operating current × operating rate)
“H” level maximum output current	I_{OH}	—	-10	mA	
“H” level average output current	I_{OHAV}	—	-2	mA	Average value (operating current × operating rate)
“H” level total maximum output current	ΣI_{OH}	—	-30	mA	
“H” level total average output current	ΣI_{OHAV}	—	-10	mA	Average value (operating current × operating rate)
Power consumption	P_D	—	200	mW	
Operating temperature	T_A	-40	+85	°C	
Storage temperature	T_{stg}	-55	+150	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Operating Conditions

($V_{SS} = V_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC}	2.2	6.0	V	Normal operation assurance range * Applied to "Single-clock MB89121/123A/125A"
		2.2	4.0	V	Normal operation assurance range * Applied to "Dual-clock MB89121/123A/125A"
		2.7	6.0	V	Normal operation assurance range * Applied to "MB89P131/P133A/P135A/PV130A"
		1.5	6.0	V	Retains the RAM state in stop mode
Operating temperature	T_A	-40	+85	°C	

* : These values vary with the operating conditions. See "Operating Voltage vs. Main Clock Operating Frequency."

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

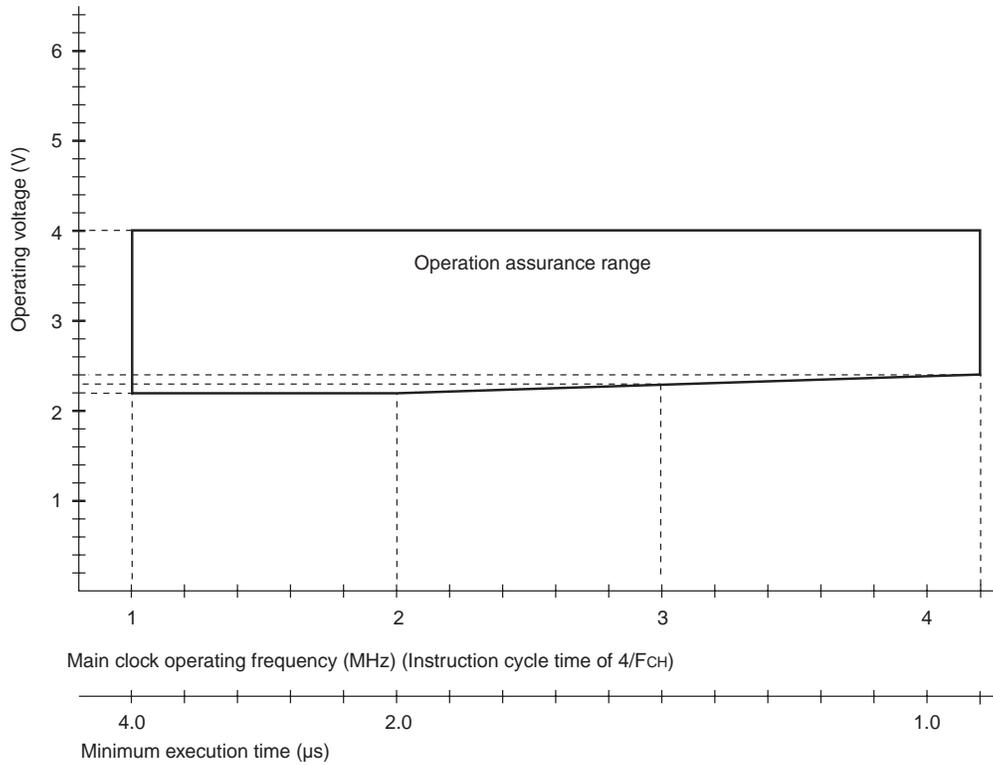
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

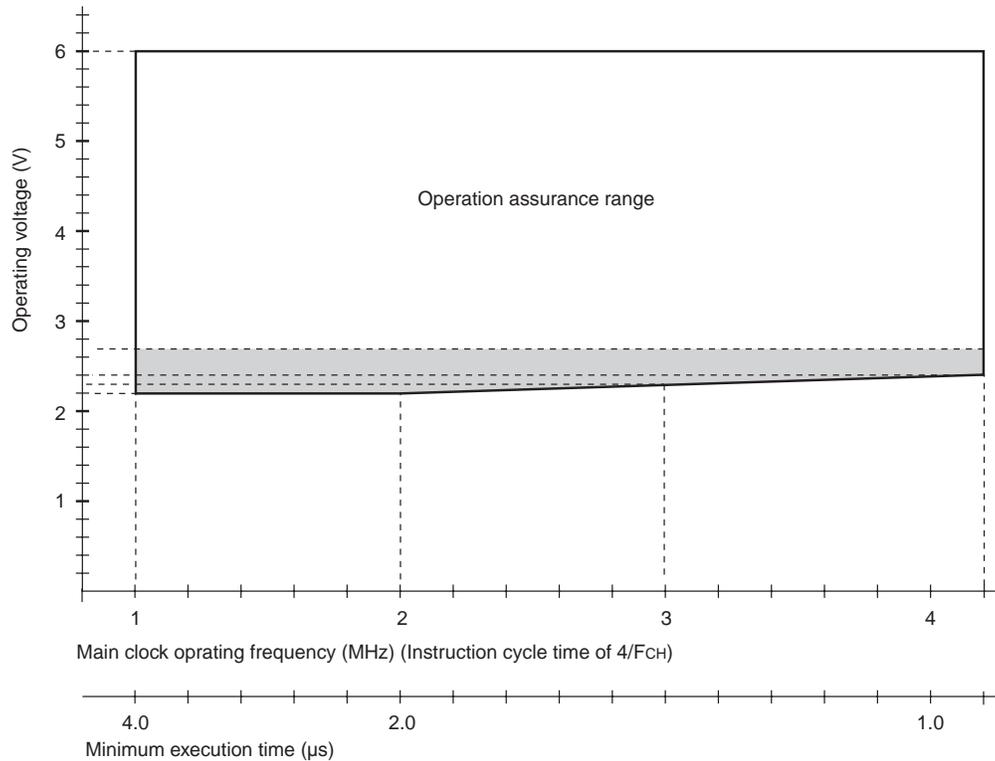
MBMB89120/120A Series

• Operating Voltage vs. Main Clock Operating Frequency

Dual-clock MB89121/123A/125A



MB89P131/P133A/P135A/PV130A, and single-clock MB89121/123A/125A



Note : The shaded area is assured only for the MB89121/123A/125A (instruction cycle time of $4/F_{CH}$) .

MBMB89120/120A Series

3. DC Characteristics

($A_{V_{CC}} = V_{CC} = +5.0\text{ V}$, $A_{V_{SS}} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
“H” level input voltage	V_{IH}	P00 to P07, P10 to P17	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	
	V_{IHS}	$\overline{\text{RST}}$, P30 to P37, $\overline{\text{INT20}}$ to $\overline{\text{INT27}}$	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	$\overline{\text{INT20}}$ to $\overline{\text{INT27}}$ are available only for the MB89120A series.
“L” level input voltage	V_{IL}	P00 to P07, P10 to P17	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	
	V_{ILS}	$\overline{\text{RST}}$, P30 to P37, $\overline{\text{INT20}}$ to $\overline{\text{INT27}}$	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	$\overline{\text{INT20}}$ to $\overline{\text{INT27}}$ are available only for the MB89120A series.
Open-drain output pin applied voltage	V_D	P40 to P43	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	
“H” level output voltage	V_{OH}	P00 to P07, P10 to P17, P20 to P27, P30 to P37	$I_{OH} = -2.0\text{ mA}$	2.4	—	—	V	
“L” level output voltage	V_{OL}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P43	$I_{OL} = 1.8\text{ mA}$	—	—	0.4	V	
	V_{OL2}	$\overline{\text{RST}}$	$I_{OL} = 4.0\text{ mA}$	—	—	0.6	V	
Input leakage current (Hi-Z output leakage current)	I_{LI}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P43, MOD0, MOD1	$0.45\text{ V} < V_I < V_{CC}$	—	—	± 5	μA	Without pull-up resistor
Pull-up resistance	R_{PULL}	P00 to P07, P10 to P17, P30 to P37, P40 to P43, $\overline{\text{RST}}$	$V_I = 0.0\text{ V}$	25	50	100	$\text{k}\Omega$	

(Continued)

MBMB89120/120A Series

(Continued)

($AV_{CC} = V_{CC} = +5.0\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
Power supply current*1	I _{CC1}	V _{CC} (External clock operation)	V _{CC} = 5.0 V F _{CH} = 4.00 MHz t _{inst} *2 = 1.0 μs	—	4	7	mA	MB89121/ 123A/125A
				—	6	10	mA	MB89P131/ P133A/ P135A
	I _{CCS1}		V _{CC} = 5.0 V F _{CH} = 4.00 MHz Main sleep mode t _{inst} *2 = 1.0 μs	—	2	5	mA	
	I _{CCL}		V _{CC} = 3.0 V F _{CL} = 32.768 kHz Sub clock mode	—	50	100	μA	MB89121/ 123A/125A
				—	1	3	mA	MB89P131/ P133A/ P135A
	I _{CCLS}		V _{CC} = 3.0 V F _{CL} = 32.768 kHz Sub clock sleep mode	—	25	50	μA	
	I _{CCT}		V _{CC} = 3.0 V F _{CL} = 32.768 kHz • Watch mode • Main clock stop mode at dual clock product	—	—	15	μA	
I _{CCH}	T _A = +25 °C • Sub clock stop mode • Main clock stop mode at single clock product	—	—	1	μA			
Input capacitance	C _{IN}	Other than AV _{CC} , AV _{SS} , V _{CC} , and V _{SS}	f = 1 MHz	—	10	—	pF	

*1 : The measurement conditions of power supply current is external clock. ($V_{CC} = 5.0\text{ V}$, $V_{CC} = 3.0\text{ V}$)

*2 : For information on t_{inst}, see “(4) Instruction Cycle” in “4. AC Characteristics.”

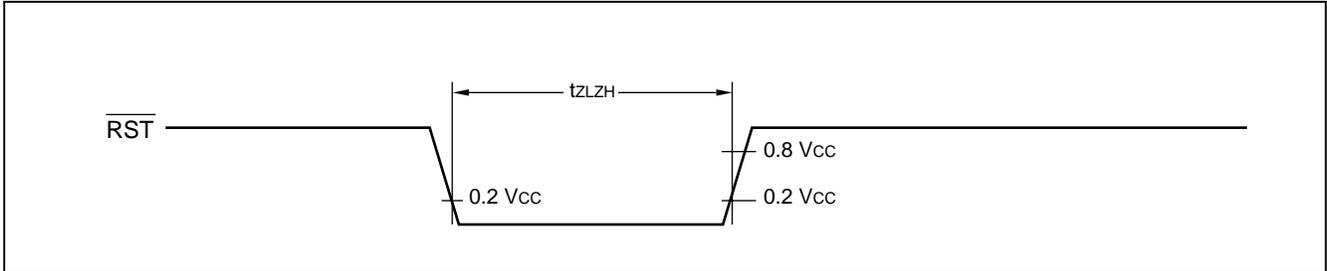
4. AC Characteristics

(1) Reset Timing

($V_{CC} = +5.0\text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
$\overline{\text{RST}}$ "L" pulse width	t_{ZLZH}	—	$48 t_{\text{HCYL}}^*$	—	ns	

* : t_{HCYL} is the oscillation cycle ($1/F_{\text{CH}}$) input to the X0.



(2) Power-on Reset

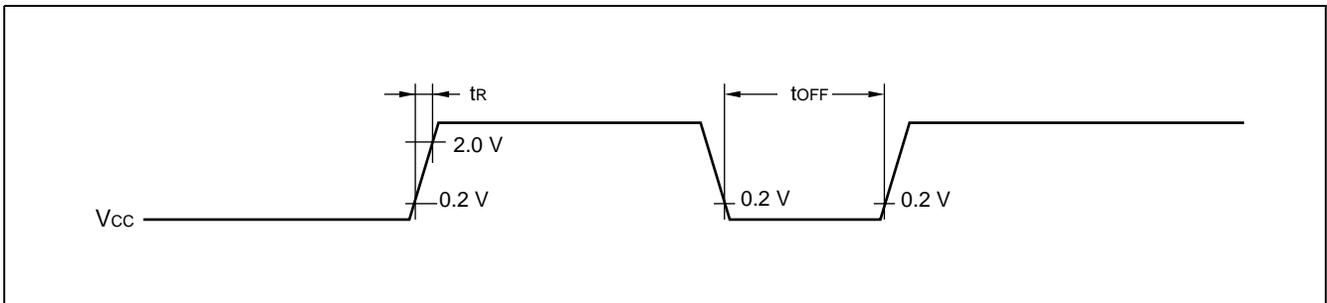
($AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
Power supply rising time	t_{R}	—	—	50	ms	Power-on reset function only
Power supply cut-off time	t_{OFF}		1	—	ms	Due to repeated operations

Note : Make sure that power supply rises within the oscillation stabilization time selected.

For example, when the main clock is operating at $F_{\text{CH}} = 3\text{ MHz}$ and the oscillation stabilization time select option has been set to $2^{12}/F_{\text{CH}}$, the oscillation stabilization wait time is 1.4 ms and accordingly the maximum value of power supply rising time is about 1.4 ms.

Keep in mind that rapid changes in power supply voltage may cause a power-on reset. If power supply voltage needs to be varied in the course of operation, a smooth voltage rise is recommended.



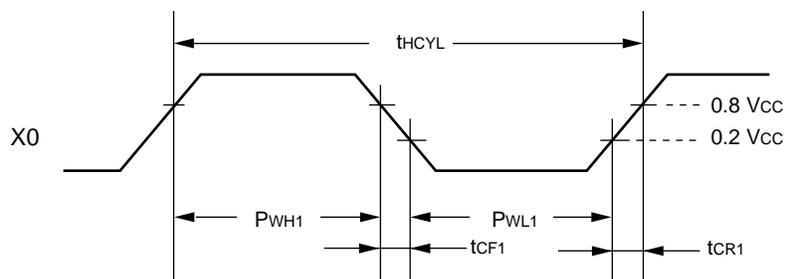
MBMB89120/120A Series

(3) Clock Timings

($V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$)

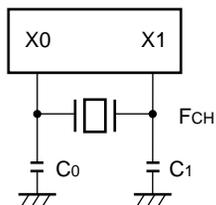
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min.	Typ.	Max.		
Clock frequency	F_{CH}	X0, X1	1	—	4.2	MHz	Main clock
	F_{CL}	X0A, X1A	—	32.768	—	kHz	Sub clock
Clock cycle time	t_{HCYL}	X0, X1	238	—	1000	ns	Main clock
	t_{LCYL}	X0A, X1A	—	30.5	—	μs	Sub clock
Input clock pulse width	P_{WH1} P_{WL1}	X0	72	—	—	ns	External clock
Input clock rising/falling time	t_{CR1} t_{CF1}	X0	—	—	24	ns	External clock

X0, X1 Timings and Conditions of Applied Voltage

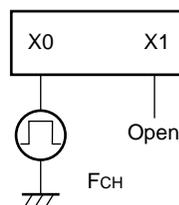


Main Clock Conditions of Applied Voltage

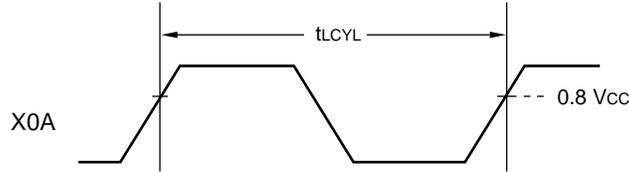
When a crystal or ceramic resonator is used



When an external clock is used

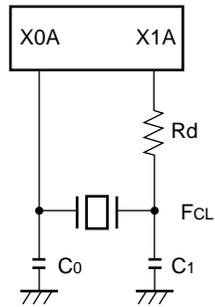


X0A, X1A Timings and Conditions of Applied Voltage

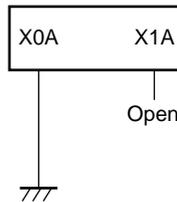


Sub clock Conditions of Applied Voltage

When a crystal or ceramic resonator is used



Single-clock option is used



(4) Instruction Cycles

($V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$)

Parameter	Symbol	Value (typical)	Unit	Remarks
Instruction cycle (minimum execution time)	t_{inst}	$4/F_{CH}$, $8/F_{CH}$, $16/F_{CH}$, $64/F_{CH}$	μs	$(4/F_{CH}) t_{inst} = 1.0 \mu\text{s}$ when operating at $F_{CH} = 4 \text{ MHz}$
		$2/F_{CL}$	μs	$t_{inst} = 61.036 \mu\text{s}$ when operating at $F_{CL} = 32.768 \text{ kHz}$

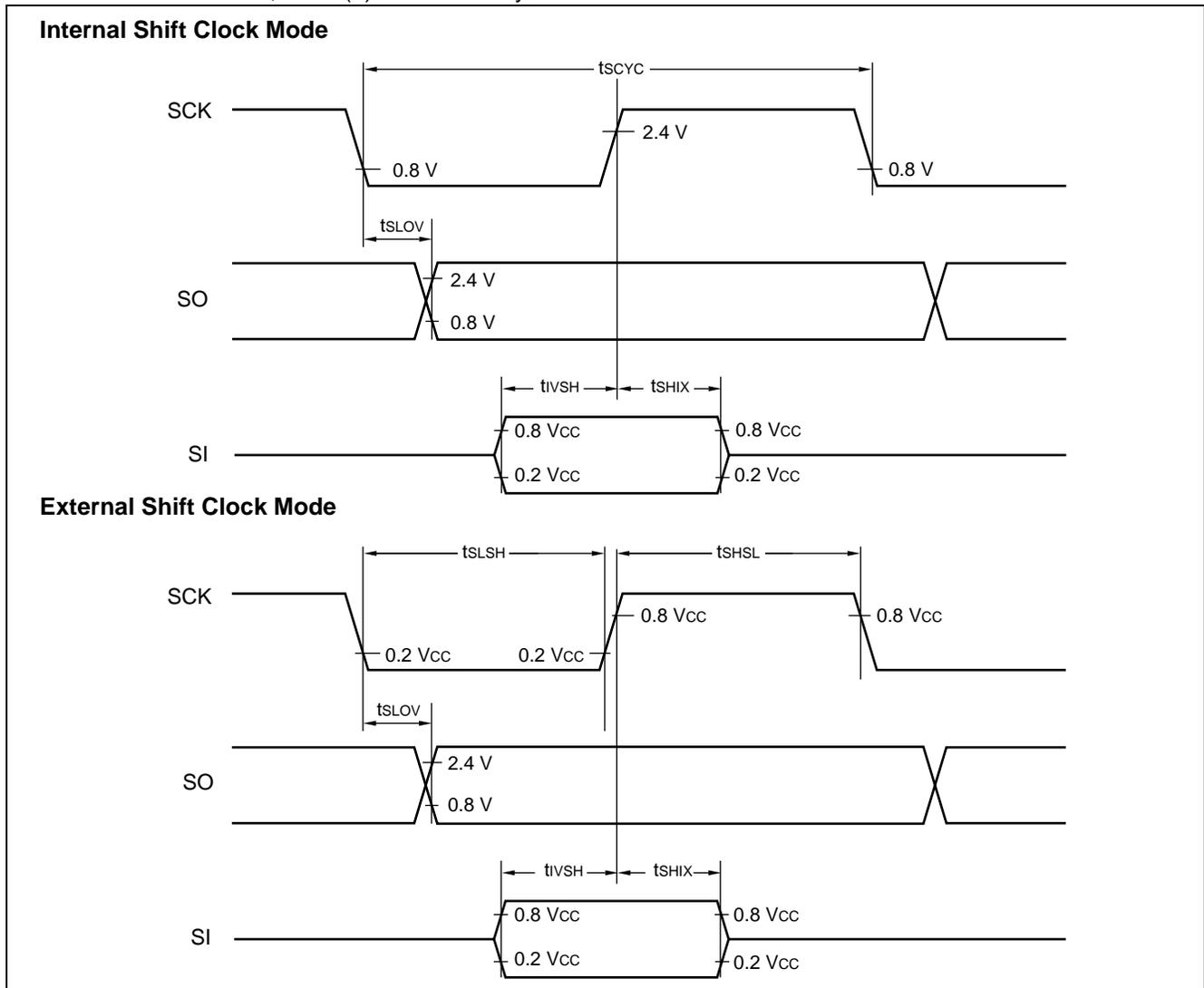
MBMB89120/120A Series

(5) Serial I/O Timings

($V_{CC} = +5.0\text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
Serial clock cycle time	t_{SCYC}	SCK	Internal clock operation	$2 t_{inst}^*$	—	μs	
SCK $\downarrow \rightarrow$ SO time	t_{SLOV}	SCK, SO		-200	200	ns	
Valid SI \rightarrow SCK \uparrow	t_{IVSH}	SI, SCK		200	—	ns	
SCK $\uparrow \rightarrow$ Valid SI hold time	t_{SHIX}	SCK, SI		200	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK	External clock operation	t_{inst}^*	—	μs	
Serial clock "L" pulse width	t_{SLSH}			t_{inst}^*	—	μs	
SCK $\downarrow \rightarrow$ SO time	t_{SLOV}	SCK, SO		0	200	ns	
Valid SI \rightarrow SCK \uparrow	t_{IVSH}	SI, SCK		200	—	ns	
SCK $\uparrow \rightarrow$ Valid SI hold time	t_{SHIX}	SCK, SI		200	—	ns	

* : For information on t_{inst} , see "(4) Instruction Cycles."



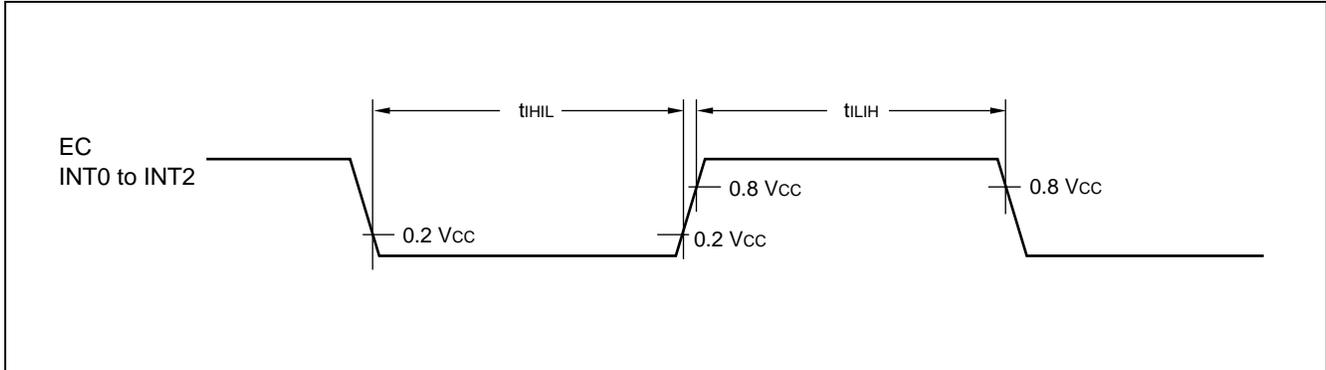
MBMB89120/120A Series

(6) Peripheral Input Timings

($V_{CC} = +5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min.	Max.		
Peripheral input "H" pulse width	t_{LIH}	EC, INT0 to INT2	$2 t_{inst}^*$	—	μS	
Peripheral input "L" pulse width	t_{HIL}		$2 t_{inst}^*$	—	μS	

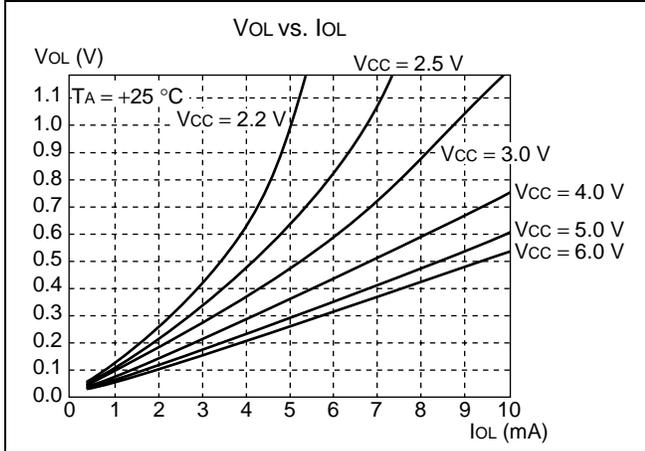
* : For information on t_{inst} , see "(4) Instruction Cycle."



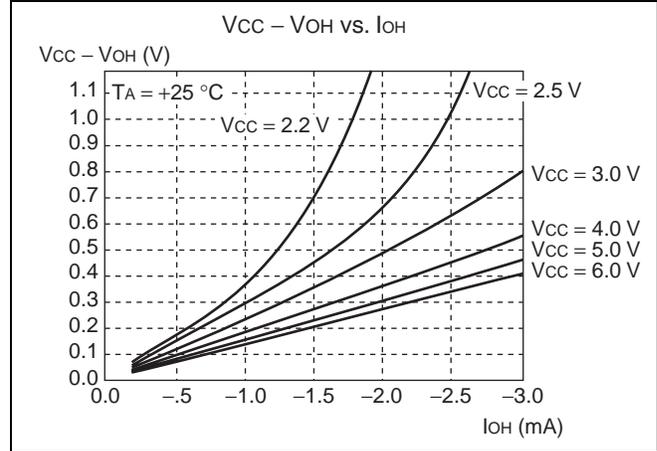
MBMB89120/120A Series

EXAMPLE CHARACTERISTICS

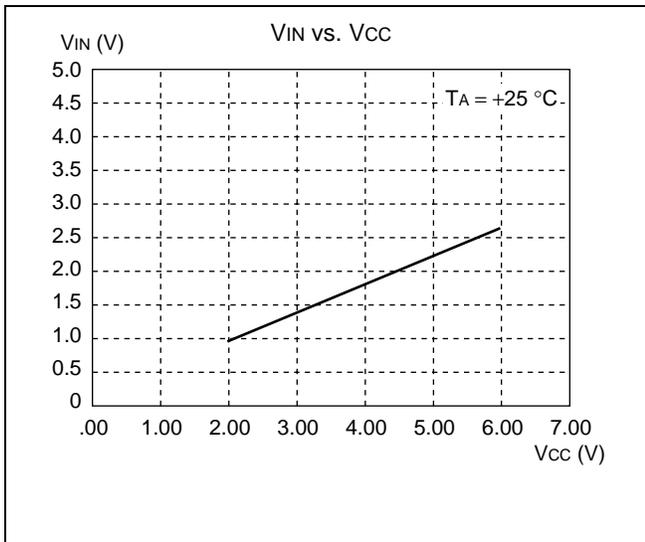
(1) "L" Level Output Voltage



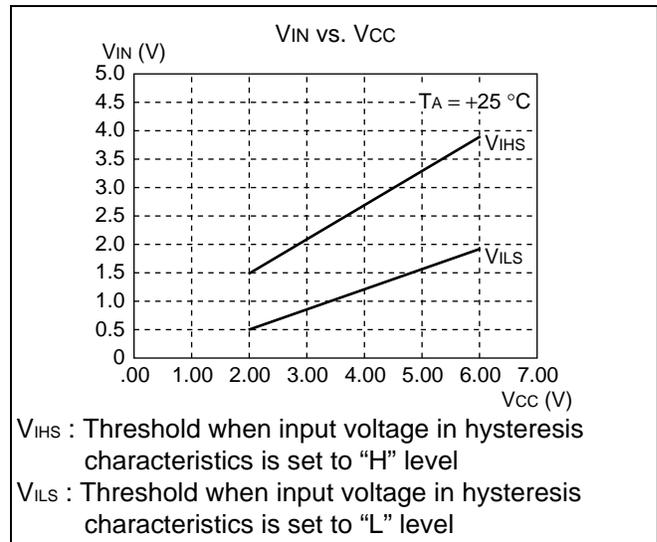
(2) "H" Level Output Voltage



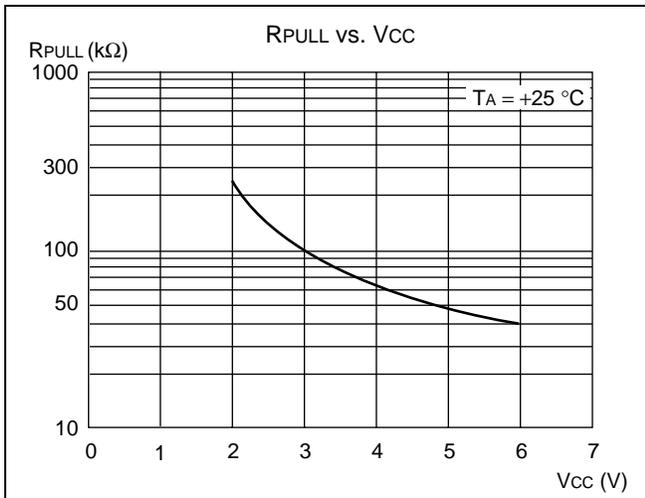
(3) "H" Level Input Voltage/"L" Level Input Voltage (CMOS Input)



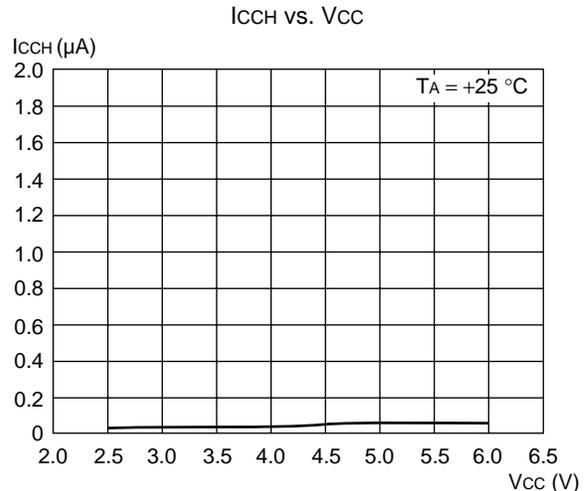
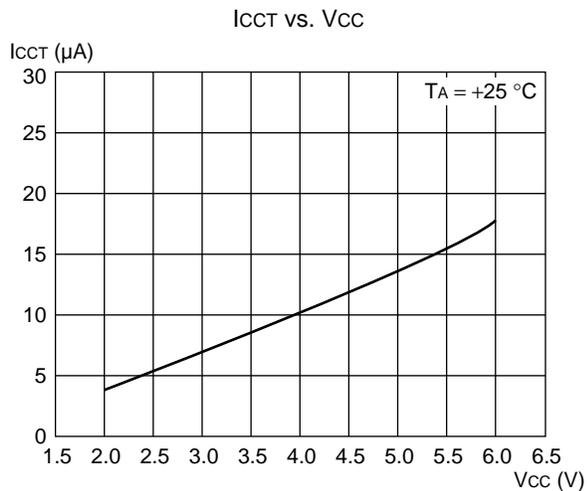
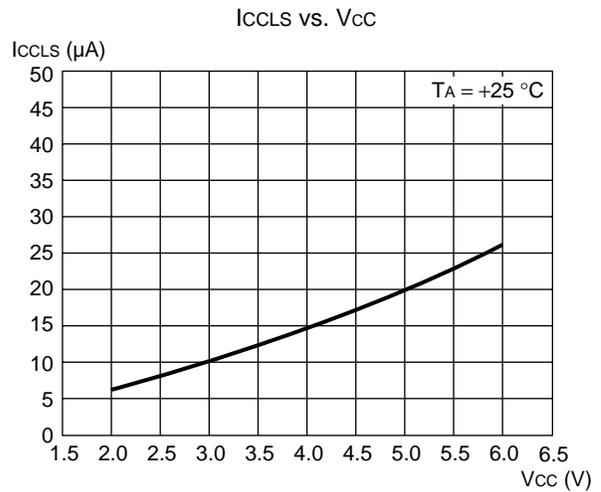
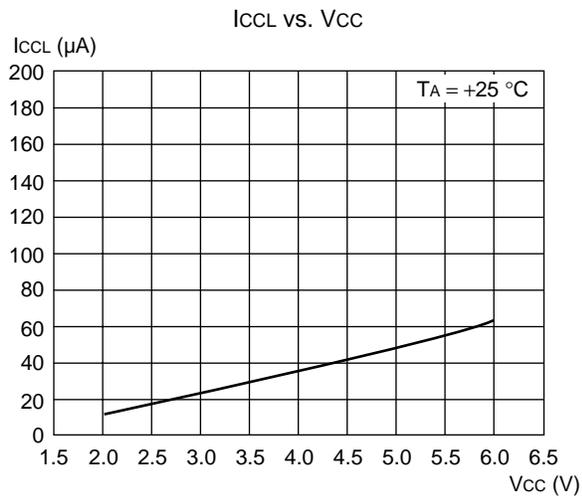
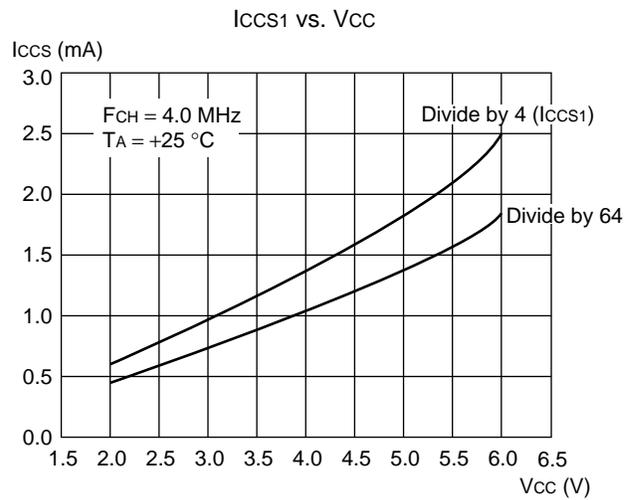
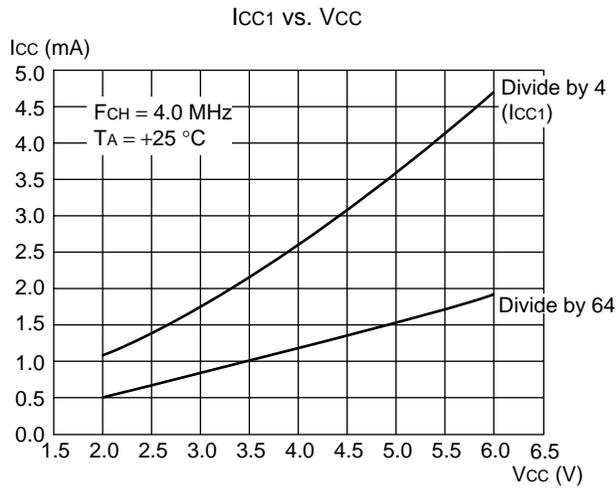
(4) "H" Level Input Voltage/"L" Level Input Voltage (Hysteresis Input)



(5) Pull-up Resistance



(6) Power Supply Current



MBMB89120/120A Series

■ MASK OPTIONS

No.	Part number	MB89121 MB89123A MB89125A	MB89P131 MB89P133A	MB89P135A	MB89PV130A
	Specifying procedure	Specify when ordering masking		Set with EPROM programmer	Specification impossible
1	Pull-up resistors <ul style="list-style-type: none"> • P00 to P07, P10 to P17, • P30 to P37, P40 to P43 	Selectable by pin	Selectable by pin (P40 to P43 must be set without a pull-up resistor.)		All pins fixed to no pull-up resistor optional
2	Power-on reset <ul style="list-style-type: none"> • Power-on reset provided • No power-on reset 	Selectable	Selectable	Selectable	With power-on reset
3	Selection of oscillation stabilization wait time <ul style="list-style-type: none"> • The oscillation stabilization wait time initial value is selectable from 4 types given below. 0 : Oscillation stabilization $2^2/F_{CH}$ 1 : Oscillation stabilization $2^{12}/F_{CH}$ 2 : Oscillation stabilization $2^{16}/F_{CH}$ 3 : Oscillation stabilization $2^{18}/F_{CH}$	Selectable	Selectable	Selectable	Oscillation stabilization $2^{18}/F_{CH}$
4	Reset pin output <ul style="list-style-type: none"> • Reset output provided • No reset output 	Selectable	Selectable	Selectable	With reset output
5	Clock mode selection <ul style="list-style-type: none"> • Single-clock mode • Dual-clock mode 	Selectable	Selectable	Selectable	Dual-clock mode
6	Main clock oscillation circuit type <ul style="list-style-type: none"> • External clock input • Oscillation resonator 	Selectable	Not required*1		
7	Peripheral control clock output function*2 <ul style="list-style-type: none"> • Not used • Used 	Selectable	Not required*3		

*1 : Can be used as either crystal or ceramics oscillation.

*2 : "Used" must be selected when P33 (39 pin) is used as SCO for the peripheral control clock output.

*3 : The peripheral control clock function can be used only by software.

MBMB89120/120A Series

■ MB89P131/P133A STANDARD OPTIONS

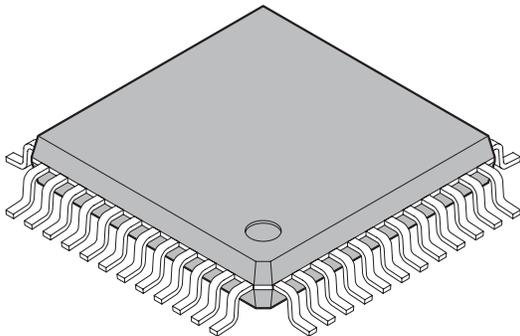
No.	Product option	MB89P131-101	MB89P133A-201
1	Pull-up resistor	Not provided for any port	Not provided for any port
2	Power-on reset	Provided	Provided
3	Selection of oscillation stabilization time	2 : Oscillation stabilization $2^{16}/F_{CH}$	2 : Oscillation stabilization $2^{16}/F_{CH}$
4	Reset pin output	Provided	Provided
5	Clock mode selection	Dual-clock mode	Dual-clock mode

■ ORDERING INFORMATION

Part number	Package	Remarks
MB89121PFM MB89123APFM MB89125APFM	48-pin Plastic QFP (FPT-48P-M13)	
MB89P131-101PFM MB89P133A-201PFM MB89P135A-101PFM		
MB89PV130ACF-ES	48-pin Ceramic MQFP (MQP-48C-P01)	

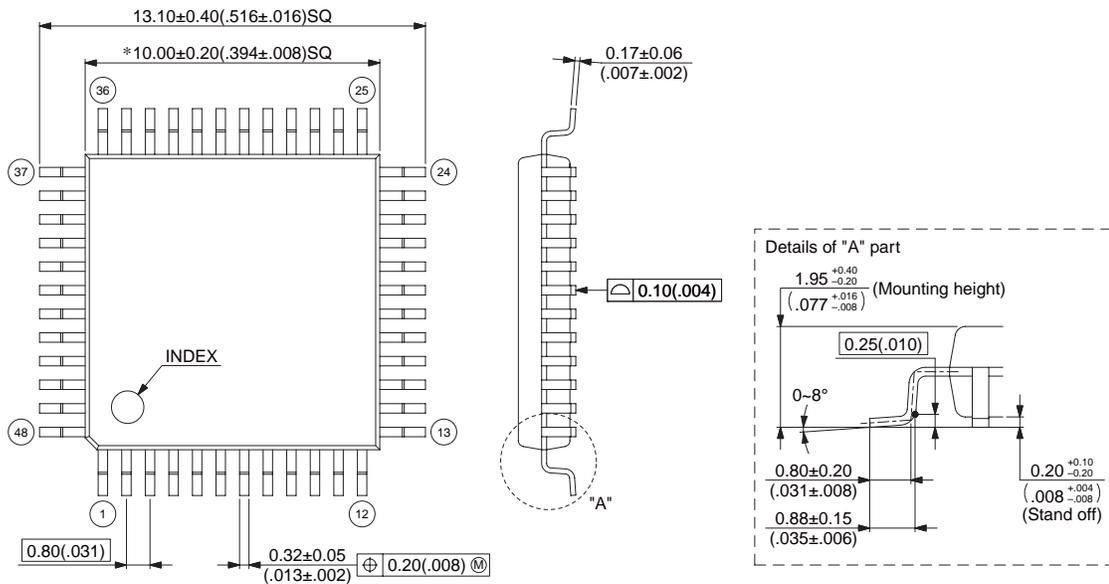
MBMB89120/120A Series

PACKAGE DIMENSION

 <p>48-pin plastic QFP</p> <p>(FPT-48P-M13)</p>	Lead pitch	0.80 mm
	Package width × package length	10 × 10 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	2.35 mm MAX
	Code (Reference)	P-QFP44-10×10-0.80

48-pin plastic QFP
(FPT-48P-M13)

Note 1) * : These dimensions do not include resin protrusion.
 Note 2) Pins width and pins thickness include plating thickness.
 Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches).
 Note: The values in parentheses are reference values.

Please check the latest package dimensions at the following URL.
<http://edevice.fujitsu.com/package/en-search/>

■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
7	■ PIN DESCRIPTION	Changed the function description of AVCC pin (pin no. 1). Power supply(GND) pin → Power supply pin
15	■ HANDLING MB89P131/P133A/ P135A	Deleted the item of “3. EPROM Programmer Socket Adapter”.
16	■ PROGRAMMING TO THE EPROM WITH PIGGYBACK/EVALUATION DEVICE	Deleted the item of “2. Programming Socket Adapter”.
31	■ ELECTRICAL CHARACTERISTICS 4. AC Characteristics	Deleted the item of “(5) Recommended Resonator Manufacturers”.
37	■ ORDERING INFORMATION	Changed the ordering information. MB89P131PFM-101 → MB89P131-101PFM MB89P133APFM-201 → MB89P133A-201PFM MB89P135APFM → MB89P135A-101PFM

The vertical lines marked in the left side of the page show the changes.

MBMB89120/120A Series

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